



FTF 2016
TECHNOLOGY FORUM

MAKE YOUR OWN 3D PRINTER WITH NXP TECHNOLOGY

FTF-SMI-2003

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PRESENTER TITLE
FTF-SMI-2003
MAY 19, 2016

PUBLIC USE



AGENDA

- What is a 3D Printer?
- Understand the basics of 3D printing
- Understand the basics of assembling a 3D printer
- How can NXP help enable your 3D printer build?
- What are the Electronics involved in creating a 3D printer?



What is 3D Printing?

**Most printers today
are FFF type:
Fused Filament
Fabrication**



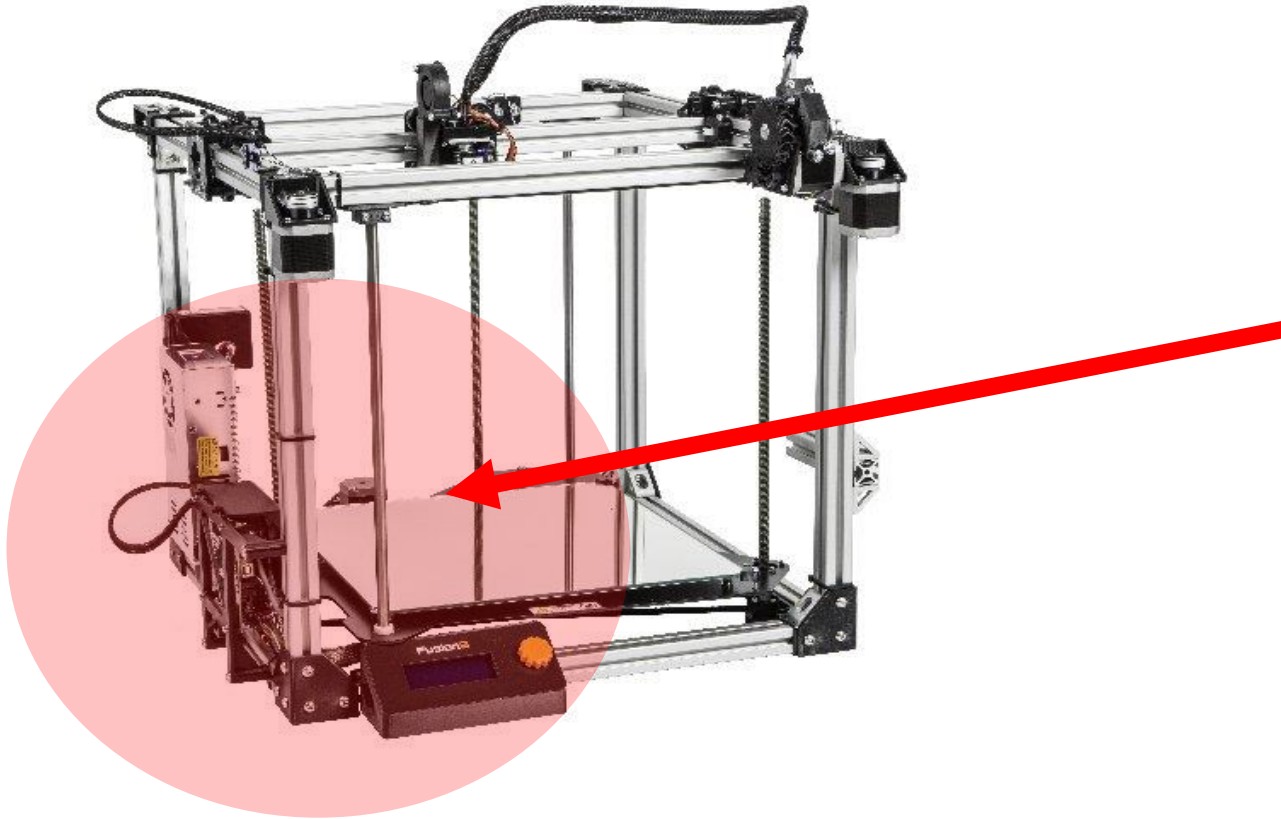
What Are the Parts that Make Up 3D Printing?

- Printer frame
- Printer mechanical slides
- Print head
- Stepper motors
- Print bed – heated
- Display
- SD card – printing files
- Power supply
- Slicing software – G-code conversion
- Plastic filament
- **ELECTRONICS!!!!**

How Can NXP Help Me Enable My 3D Printer? ...Electronics!

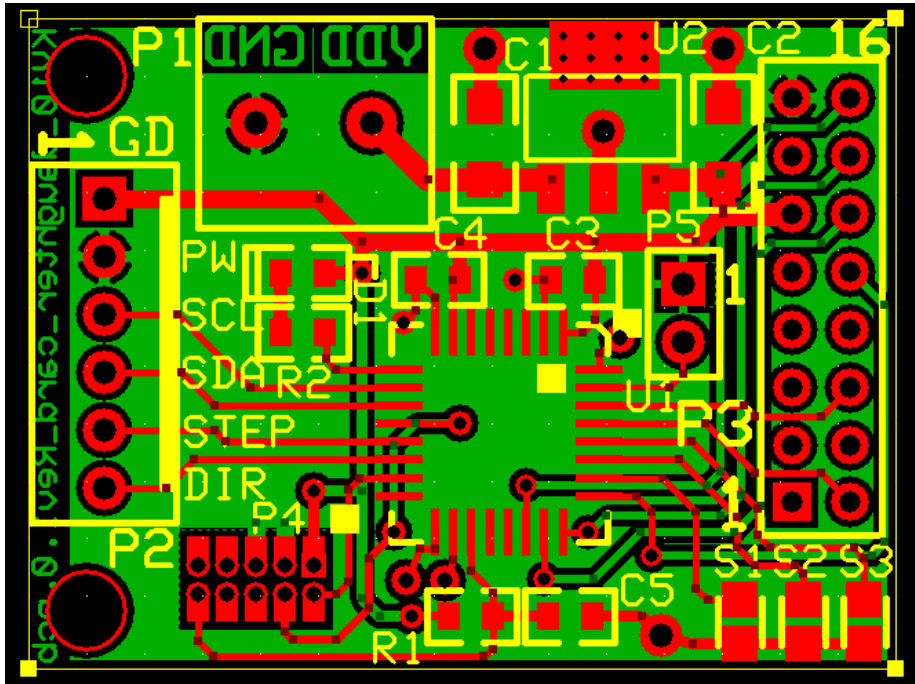
- NXP has just about everything in the electronics that you need to get your 3D printer up and running!
 - Microcontrollers – ARM® Cortex® Core-M0+, M4
 - Power supply components
 - Motor control components
 - MOSFETS
 - DC-to-DC converters
 - Transistors
 - Temperature sensors
 - H-Bridge pre-drivers
 - Motor Control Software - Kinetis motor suite!
 - Stepper motor control library code

See Where NXP Can Help Enable Your Design for Hardware!

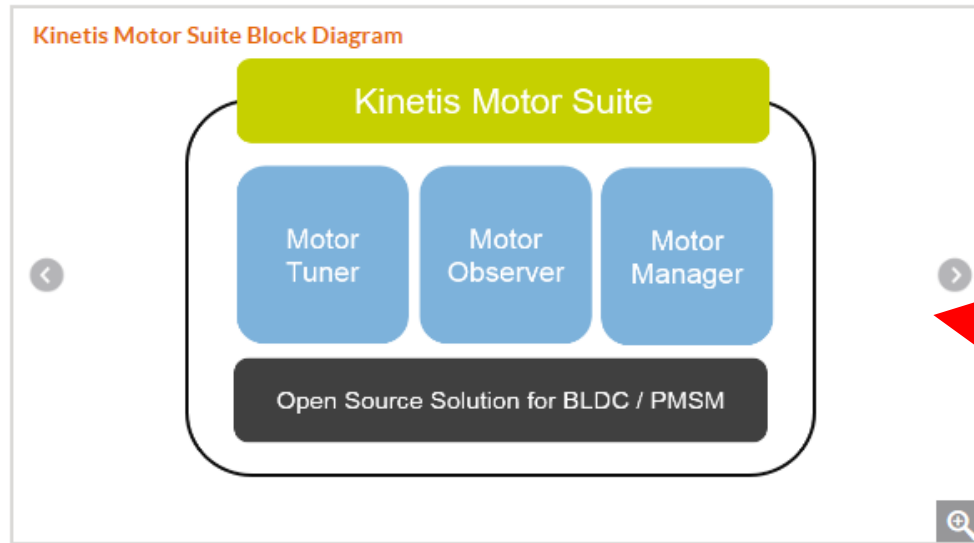


Microcontrollers – ARM M0+, M4
Power supply components
Motor control components
MOSFETS
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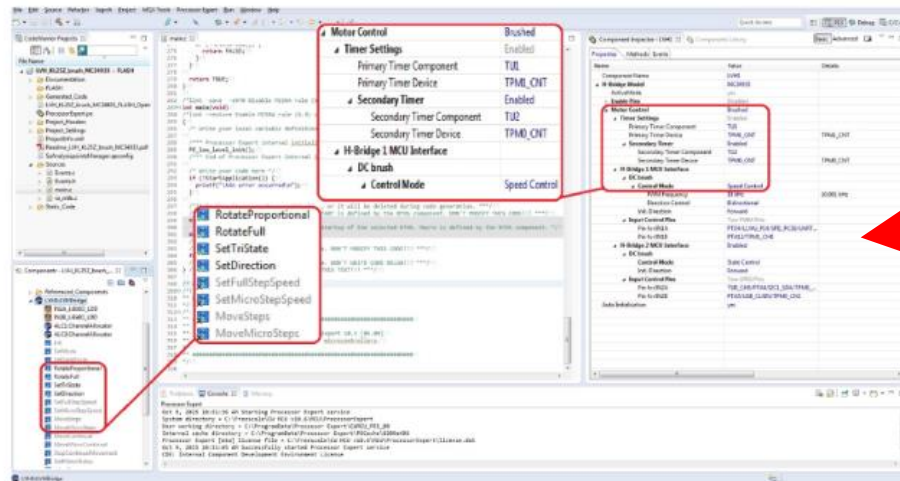
Custom Hardware Using the MKV10 Microcontroller as Motor Drives



See Where NXP Can Help Enable Your Design for Software!



Motor Control Software - Kinetic Motor Suite!

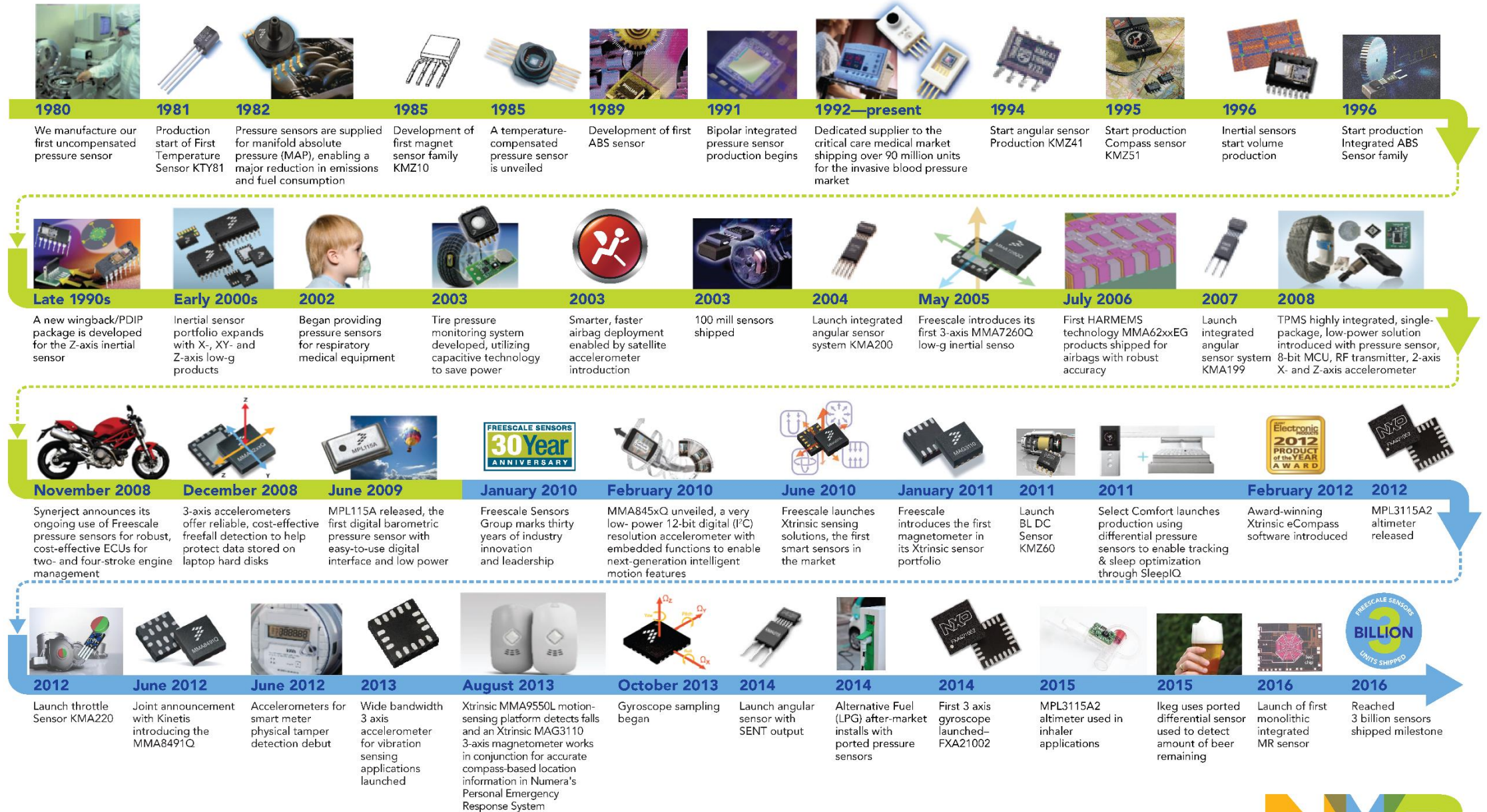


Stepper Motor control library code

**COME DOWN TO THE
TECH LAB TO SEE A
DEMONSTRATION OF
THE NXP 3D PRINTER!**



SENSOR PRODUCTS TIMELINE



Other Sensor Sessions This Week

Session	Day	Time	Title	Room
FTF-SMI-N1946	Monday	16:15	Build Better Drones with NXP Products	301 & 302 – Level 3*
FTF-AUT-N1821	Tuesday	11:00	Automotive Sensors Portfolio	Lone Star Ballroom E - Level 3
FTF-INS-N1820	Tuesday	14:30	Hands-On Workshop: Sensor Mining and Algorithm Development (Reserved Seat Required)	Griffin Hall 1 - Level 2
FTF-INS-N2014	Wednesday	11:00	Collecting and Analyzing Sensor Data Readily using NXP Hardware and Software Tools Including Kinetis SDK and IS-SDK	Lone Star Ballroom H - Level 3
FTF-INS-N1819	Wednesday	14:30	Sensor Deep-Dive Demos and Data Collection Techniques	Lone Star Ballroom H - Level 3
FTF-INS-N1816	Wednesday	16:45	Sensors for Industrial and Medical IoT Applications	301 & 302 - Level 3
FTF-INS-N1818	Thursday	9:00	The Fundamentals of Sensor Data Analytics	301 & 302 - Level 3
FTF-INS-N1817	Thursday	09:00	Introduction to Sensor Toolbox and IoT Sensing SDK	Lone Star Ballroom F – Level 3
FTF-SMI-N2003	Thursday	11:00	Make Your Own 3D Printer with NXP Technology	Lone Star Ballroom G - Level 3





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